

Discription

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a DFN1006(SOD-882) leadless ultra small Surface-Mounted Device (SMD) plastic package designed to protect one signal line from the damage caused by ESD and other transients.

Features

- ★ Bidirectional ESD protection of one line
- ★ Low operating voltage: 7.0 V
- ★ Low clamping voltage VC = 13V @8A
- ★ Response time is typically<1ns
- ★ Ultra Low Leakage:nALevel
- ★ IEC 61000-4-2: level 4 (ESD)
- ★ IEC 61000-4-5 (surge): IPPMQ 8A



DFN1006-2L



Circuit Diagram

Applications

- ★ Portable electronics
- ★ Computers and peripherals
- ★ Audio and video equipment
- ★ Cellular handsets and accessories
- ★ Communication systems
- ★ Power supplies

Ordering information

Product ID	Pack	Qty(PCS)
PESD7V0L1BSLAZ	DFN1006-2L	10000



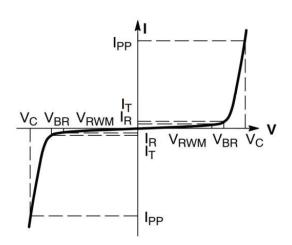
Absolute Ratings(Tamb = 25°C)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp = 8/20µs)	РРРМ	104	W
Maximum lead temperature for soldering during 10s	T∟	260	°C
Storage Temperature Range	Tstg	-55 to +150	°C
Operating Temperature Range	Тор	-40 to +125	°C
Maximum junction temperature	Tj	150	°C
ESD voltage IEC 61000-4-2 (air discharge)	VESD	20	kV
ESD voltage IEC 61000-4-2 (contact discharge)	VESD	15	kV

Electrical Characteristics

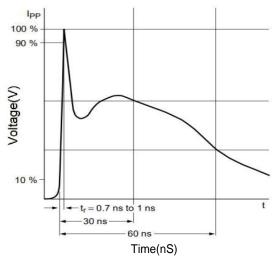
Parameter	Symbol	Min	Тур	Max	Unit	Condition
Reverse Working Voltage	VRWM			7.0	V	
Breakdown Voltage	V _{BR}	7.6	8.2	9.0	V	I⊤=1mA
Leakage Current ILeak	lR			0.1	nA	V _{RWM} =7.0V
Clamping Voltage	Vc		10.0	12.0	V	І _{РР} =5А,Тр=8/20µs
Clamping Voltage	Vc		11.5	13.0	V	І _{РР} =8А,Тр=8/20µs
Junction Capacitance	Cı		18.0		pF	V _R =0V, f=1MHz

Symbol	Parameter
Іррм	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
VRWM	Working Peak Reverse Voltage
lr	Reverse Leakage Current @ VRWM
lτ	Test Current
VBR	Breakdown Voltage @ Іт

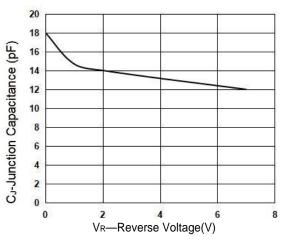




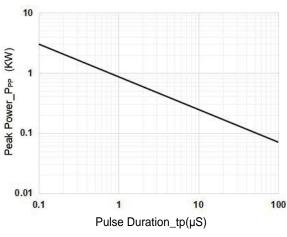
Typical Characteristics



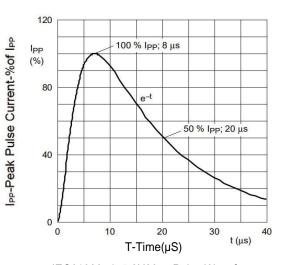
IEC61000-4-2 Pulse Waveform



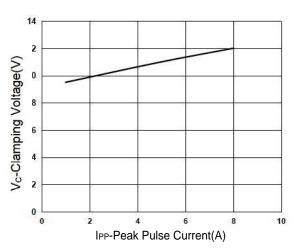
Junction Capacitance vs. Reverse Voltage



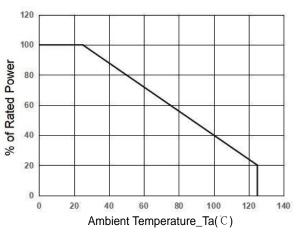
Peak Pulse Power vs. Pulse Time



IEC61000-4-5 8X20µs Pulse Waveform



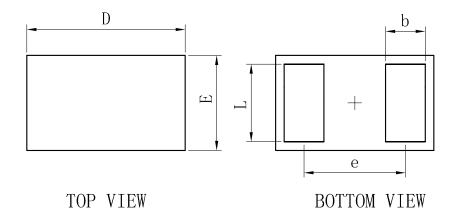
Clamping Voltage vs. Peak Pulse Current



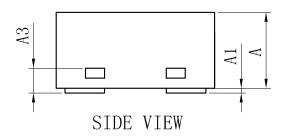
Power Derating Curve



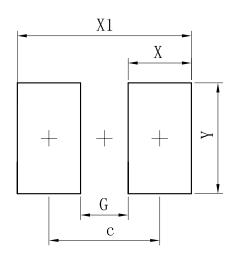
Outline And Dimensions



DFN1006-2L				
Dim	Min	Тур	Max	
D	0. 95	1.00	1.05	
Е	0. 55	0.60	0.65	
е	_	0.64	_	
L	0.44	0.49	0. 54	
b	0.20	0. 25	0.30	
A	0.43	0.48	0. 53	
A1	0	_	0.05	
A3 0. 127REF.				
All Dimensions in mm				



Soledering Footprint



Dimensions	(mm)
С	0.70
G	0.30
X	0.40
X1	1.10
Y	0.70

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